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Feature Paper in Section Smart Materials

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Message from the Guest Editor

Dear Colleagues,

The Special Issue “**Feature Paper in Section Smart Materials**” will present a collection of high-quality original research papers and comprehensive reviews on the recent advances in the field of functional and smart materials for energy devices, electronics, soft robotics, sensors, and actuators. This Special Issue intends to highlight new knowledge and the latest innovative approaches and developments in all aspects of the synthesis, processing, characterization, and performance of functional and smart materials and their integration in existing and emerging applications. The potential topics include, but are not limited to:

- Energy generation devices
- Energy storage devices
- Sensors
- Actuators
- Flexible electronics
- Stretchable electronics
- Wearable electronics
- Soft robotics
- Biomechanics
- Display

Prof. Dr. Seung Hwan Ko
Guest Editor



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Special Issue



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Message from the Editor-in-Chief

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